Digital Output Temperature Sensor

Description

The CAT6095 is a JEDEC JC42.4 compliant Temperature Sensor designed for general purpose temperature measurements requiring a digital output.

The CAT6095 measures temperature at least 10 times every second. Temperature readings can be retrieved by the host via the serial interface, and are compared to high, low and critical trigger limits stored into internal registers. Over or under limit conditions can be signaled on the open-drain EVENT pin.

The CAT6095 is packaged in space saving TDFN package with exposed backside die attach pads (DAP). The exposed DAP reduces overall thermal resistance, thus providing faster response to thermal changes when compared to SOIC, TSSOP or SOT packages.

Features

- JEDEC JC42.4 Compliant Temperature Sensor
- Temperature Range: -40°C to +125°C
- Supply Range: $3.3 \text{ V} \pm 10\%$
- I²C / SMBus Interface
- Schmitt Triggers and Noise Suppression Filters on SCL and SDA Inputs
- Low Power CMOS Technology
- 2 x 3 x 0.75 mm TDFN Package
- These Devices are Pb-Free and are RoHS Compliant

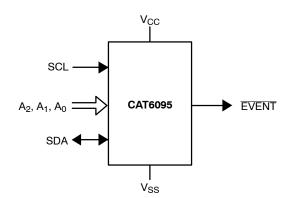


Figure 1. Functional Symbol

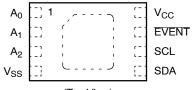


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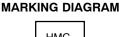


PIN CONFIGURATION

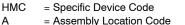


(Top View)

For the location of Pin 1, please consult the corresponding package drawing.







- LL = Assembly Lot Number (Last Two Digits)
- = Production Year (Last Digit) Υ
- = Production Month (1 9, O, N, D) Μ
 - = Pb-Free Package

А

PIN FUNCTIONS

| Pin Name | Function |
|--|----------------------------------|
| A ₀ , A ₁ , A ₂ | Device Address Input |
| SDA | Serial Data Input/Output |
| SCL | Serial Clock Input |
| EVENT | Open-drain Event Output |
| V _{CC} | Power Supply |
| V _{SS} | Ground |
| DAP | Backside Exposed DAP at V_{SS} |

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 15 of this data sheet.

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Table 1. ABSOLUTE MAXIMUM RATINGS

| Parameter | Rating | Units |
|--|--------------|-------|
| Operating Temperature | –45 to +130 | °C |
| Storage Temperature | −65 to +150 | °C |
| Voltage on any pin with respect to Ground (Note 1) | –0.5 to +6.5 | V |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The DC input voltage on any pin should not be lower than -0.5 V or higher than $V_{CC} + 0.5$ V. The A_0 pin can be raised to a HV level compatible with the use of a DDR3 SPD device sharing the bus with the TS. SCL and SDA inputs can be raised to the maximum limit, irrespective of V_{CC} .

Table 2. TEMPERATURE CHARACTERISTICS (V_{CC} = $3.3 \text{ V} \pm 10\%$, T_A = -40° C to $+125^{\circ}$ C, unless otherwise specified)

| Parameter | Test Conditions/Comments | Мах | Unit |
|---|---|--------|------|
| Temperature Reading Error | +75°C \leq T_A \leq +95°C, active range | ±1.0 | °C |
| Class B, JC42.4 compliant | $+40^{\circ}C \leq T_A \leq +125^{\circ}C, \mbox{ monitor range}$ | ±2.0 | °C |
| | $-20^{\circ}C \leq T_A \leq +125^{\circ}C,$ sensing range | ±3.0 | °C |
| ADC Resolution | | 12 | Bits |
| Temperature Resolution | | 0.0625 | °C |
| Temperature Conversion Time | | 100 | ms |
| Thermal Resistance (Note 2) θ_{JA} | Junction-to-Ambient (Still Air) | 92 | °C/W |

2. Power Dissipation is defined as $P_J = (T_J - T_A)/\theta_{JA}$, where T_J is the junction temperature and T_A is the ambient temperature. The thermal resistance value refers to the case of a package being used on a standard 2–layer PCB.

| Symbol | Parameter | Test Conditions/Comments | Min | Max | Unit |
|-------------------|-------------------------|---|---------------------|-----------------------|------|
| I _{CC} | Supply Current | TS active | | 200 | μΑ |
| I _{SHDN} | | TS shut-down; no bus activity | | 10 | μΑ |
| ١L | I/O Pin Leakage Current | Pin at GND or V_{CC} | | 2 | μΑ |
| V _{IL} | Input Low Voltage | | -0.5 | $0.3 \times V_{CC}$ | V |
| V _{IH} | Input High Voltage | | $0.7 \times V_{CC}$ | V _{CC} + 0.5 | V |
| V _{OL} | Output Low Voltage | $I_{OL} = 3 \text{ mA}, V_{CC} > 2.5 \text{ V}$ | | 0.4 | V |

Table 3. D.C. OPERATING CHARACTERISTICS (V_{CC} = $3.3 \text{ V} \pm 10\%$, T_A = -40° C to $+125^{\circ}$ C, unless otherwise specified)

| Symbol | Parameter | Min | Max | Units |
|-------------------------------|---|------|-----|-------|
| F _{SCL} (Note 4) | Clock Frequency | 10 | 400 | kHz |
| t _{HIGH} | High Period of SCL Clock | 600 | | ns |
| t _{LOW} | Low Period of SCL Clock | 1300 | | ns |
| t _{TIMEOUT} (Note 4) | SMBus SCL Clock Low Timeout | 25 | 35 | ms |
| t _R (Note 5) | SDA and SCL Rise Time | | 300 | ns |
| t _F (Note 5) | SDA and SCL Fall Time | | 300 | ns |
| t _{SU:DAT} (Note 6) | Data Setup Time | 100 | | ns |
| t _{HD:DAT} (Note 5) | Data Hold Time (for Input Data) | 0 | | ns |
| | Data Hold Time (for Output Data) | 300 | 900 | ns |
| tsu:sta | START Condition Setup Time | 600 | | ns |
| t _{HD:STA} | START Condition Hold Time | 600 | | ns |
| t _{SU:STO} | STOP Condition Setup Time | 600 | | ns |
| t _{BUF} | Bus Free Time Between STOP and START | 1300 | | ns |
| Τ _i | Noise Pulse Filtered at SCL and SDA Inputs | | 100 | ns |
| t _{PU} (Note 7) | Power-up Delay to Valid Temperature Recording | | 100 | ms |

Table 4. A.C. CHARACTERISTICS ($V_{CC} = 3.3 V \pm 10\%$, $T_A = -40^{\circ}C$ to +125°C) (Note 3)

3. Timing reference points are set at 30%, respectively 70% of V_{CC}, as illustrated in Figure 11. Bus loading must be such as to allow meeting

the V_{LL} , V_{OL} as well as the various timing limits. The TS interface will reset itself and will release the SDA line if the SCL line stays low beyond the t_{TIMEOUT} limit. The time–out count is started (and then re–started) on every negative transition of SCL in the time interval between START and STOP. 4.

5. In a "Wired-OR" system (such as I²C or SMBus), SDA rise time is determined by bus loading. Since each bus pull-down device must be able to sink the (external) bus pull-up current (in order to meet the VIL and/or VOL limits), it follows that SDA fall time is inherently faster than SDA rise time. SDA rise time can exceed the standard recommended t_R limit, as long as it does not exceed $t_{LOW} - t_{HD:DAT} - t_{SU:DAT}$, where t_{LOW} and $t_{HD:DAT}$ are actual values (rather than spec limits). A shorter $t_{HD:DAT}$ leaves more room for a longer SDA t_R , allowing for a more capacitive bus or a larger bus pull-up resistor. At the minimum tLOW spec limit of 1300 ns, the maximum tHD:DAT of 900 ns demands a maximum SDA t_R of 300 ns. The CAT6095's maximum t_{HD:DAT} is <700 ns, thus allowing for an SDA t_R of up to 500 ns at minimum t_{LOW}. 6. The minimum t_{SU:DAT} of 100 ns is a limit recommended by standards. The TS will accept a t_{SU:DAT} of 0 ns.

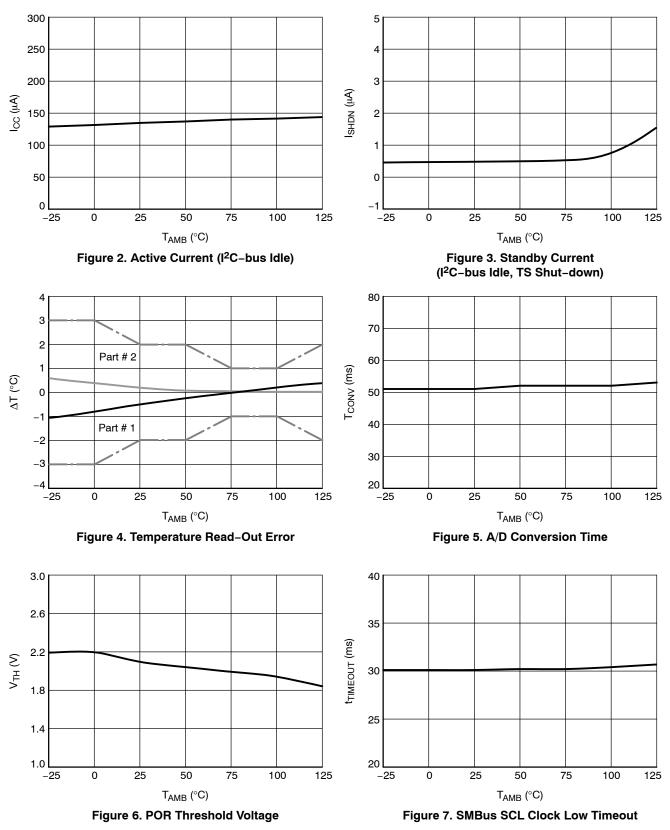
7. The first valid temperature recording can be expected after t_{PU} at nominal supply voltage.

Table 5. PIN CAPACITANCE ($T_A = 25^{\circ}C$, $V_{CC} = 3.3$ V, f = 1 MHz)

| Symbol | Parameter | Test Conditions/Comments | Min | Max | Unit |
|-----------------|--------------------------------|--------------------------|-----|-----|------|
| C _{IN} | SDA, EVENT Pin Capacitance | V _{IN} = 0 | | 8 | pF |
| | Input Capacitance (other pins) | V _{IN} = 0 | | 6 | pF |



(V_{CC} = 3.3 V, T_A = -25° C to $+125^{\circ}$ C, unless otherwise specified.)



Pin Description

SCL: The Serial Clock input pin accepts the Serial Clock generated by the Master (Host).

SDA: The Serial Data I/O pin receives input data and transmits data stored in the internal registers. In transmit mode, this pin is open drain. Data is acquired on the positive edge, and is delivered on the negative edge of SCL.

A0, A1 and A2: The Address pins set the device address. These pins have on-chip pull-down resistors.

EVENT: The open-drain **EVENT** pin can be programmed to signal over/under temperature limit conditions.

Power-On Reset

The CAT6095 incorporates Power–On Reset (POR) circuitry which monitors the supply voltage, and then resets (initializes) the internal state machine below a POR trigger level of approximately 2.0 V, i.e. well below the minimum recommended V_{CC} value.

The temperature sensor (TS) powers-up into conversion mode. The internal state machine will operate properly above the POR trigger level, but valid temperature readings can be expected only after the first conversion cycle started and completed at nominal supply voltage.

Device Interface

The CAT6095 supports I²C and SMBus data transmission protocols. These protocols describe serial communication between transmitters and receivers sharing a 2-wire data bus. Data flow is controlled by a Master device, which generates the serial clock and the START and STOP conditions. The CAT6095 acts as a Slave device. Master and Slave alternate as transmitter and receiver. Up to 8 CAT6095 devices may be present on the bus simultaneously, and can be individually addressed by matching the logic state of the address inputs A0, A1, and A2.

I²C/SMBus Protocol

The I²C/SMBus uses two 'wires', one for clock (SCL) and one for data (SDA). The two wires are connected to the V_{CC} supply via pull-up resistors. Master and Slave devices connect to the bus via their respective SCL and SDA pins. The transmitting device pulls down the SDA line to 'transmit' a '0' and releases it to 'transmit' a '1'.

Data transfer may be initiated only when the bus is not busy (see A.C. Characteristics).

During data transfer, the SDA line must remain stable while the SCL line is HIGH. An SDA transition while SCL is HIGH will be interpreted as a START or STOP condition (Figure 8).

START

The START condition precedes all commands. It consists of a HIGH to LOW transition on SDA while SCL is HIGH. The START acts as a 'wake-up' call to all Slaves. Absent a START, a Slave will not respond to commands.

STOP

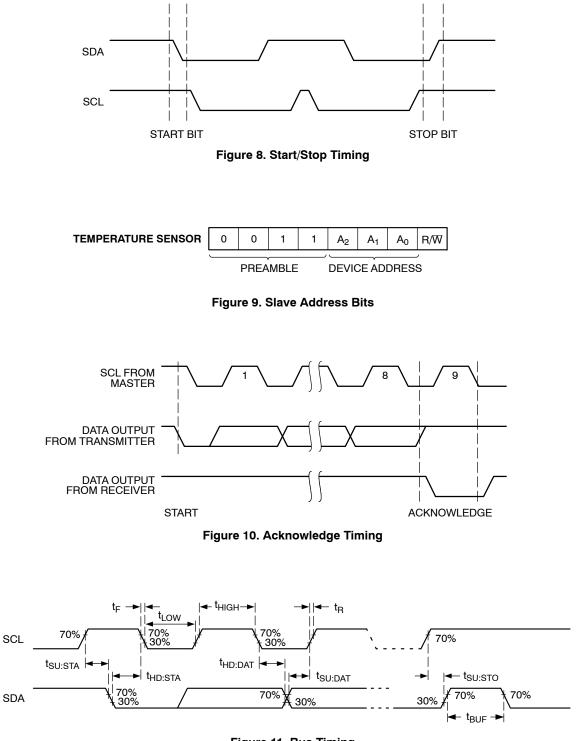
The STOP condition completes all commands. It consists of a LOW to HIGH transition on SDA while SCL is HIGH. The STOP tells the Slave that no more data will be written to or read from the Slave.

Device Addressing

The Master initiates data transfer by creating a START condition on the bus. The Master then broadcasts an 8-bit serial Slave address. The first 4 bits of the Slave address (the preamble) select the Temperature Sensor (TS preamble = 0011) as shown in Figure 9. The next 3 bits, A2, A1 and A0, select one of 8 possible TS Slave devices. The last bit, R/\overline{W} , specifies whether a Read (1) or Write (0) operation is being performed.

Acknowledge

A matching Slave address is acknowledged (ACK) by the Slave by pulling down the SDA line during the 9th clock cycle (Figure 10). After that, the Slave will acknowledge all data bytes sent to the bus by the Master. When the Slave is the transmitter, the Master will in turn acknowledge data bytes in the 9th clock cycle. The Slave will stop transmitting after the Master does not respond with acknowledge (NoACK) and then issues a STOP. Bus timing is illustrated in Figure 11.





Write Operations

Temperature Sensor Register Write

To write data to a TS register the Master creates a START condition on the bus, and then sends out the appropriate Slave address (with the R/W bit set to '0'), followed by an address byte and two data bytes. The matching Slave will acknowledge the Slave address, TS register address and the TS register data (Figure 12). The Master then ends the session by creating a STOP condition on the bus. The STOP completes the TS register update. Note that all registers in the TS are 'volatile' meaning any data contained in them is lost when power is removed from the chip.

Read Operations

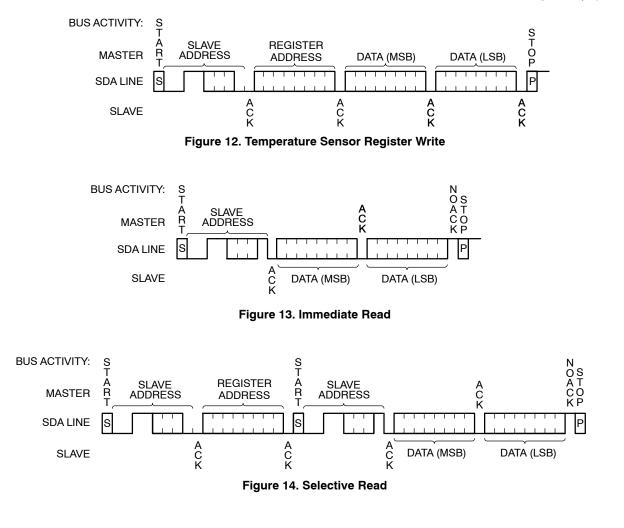
Immediate Read

Upon power-up, the Temperature Sensor (TS) address counter is initialized to 00h. The TS address counter will thus point to the Capability Register. This address counter may be updated by subsequent operations.

A CAT6095 presented with a Slave address containing a '1' in the R/\overline{W} position will acknowledge the Slave address and will then start transmitting data being pointed at by the current TS register address counter. The Master stops this transmission by responding with NoACK, followed by a STOP (Figure 13).

Selective Read

The Read operation can be started at an address different from the one stored in the address counter, by preceding the Immediate Read sequence with a 'data less' Write operation. The Master sends out a START, Slave address and address byte, but rather than following up with data (as in a Write operation), the Master then issues another START and continuous with an Immediate Read sequence (Figure 14).



Temperature Sensor Operation

The CAT6095 temperature sensor (TS) combines a Proportional to Absolute Temperature (PTAT) sensor with a Σ - Δ modulator, yielding a 12 bit plus sign digital temperature representation.

The TS runs on an internal clock, and starts a new conversion cycle at least every 100 ms. The result of the most recent conversion is stored in the **Temperature Data Register (TDR)**, and remains there following a TS Shut–Down. Reading from the **TDR** does not interfere with the conversion cycle.

The value stored in the **TDR** is compared against limits stored in the **High Limit Register (HLR)**, the **Low Limit Register (LLR)** and/or **Critical Temperature Register** (**CTR**). If the measured value is outside the alarm limits or above the critical limit, then the **EVENT** pin may be asserted. The **EVENT** output function is programmable, via the **Configuration Register** for interrupt mode, comparator mode and polarity.

The temperature limit registers can be Read or Written by the host, via the serial interface. At power-on, all the (writable) internal registers default to 0x0000, and should therefore be initialized by the host to the desired values. The <u>EVENT</u> output starts out disabled (corresponding to polarity active low); thus preventing irrelevant event bus activity before the limit registers are initialized. While the TS is enabled (not shut-down), event conditions are normally generated by a change in measured temperature as recorded in the TDR, but limit changes can also trigger events as soon as the new limit creates an event condition, i.e. asynchronously with the temperature sampling activity.

In order to minimize the thermal resistance between sensor and PCB, it is recommended that the exposed backside die attach pad (DAP) be soldered to the PCB ground plane.

Registers

The CAT6095 contains eight 16-bit wide registers allocated to TS functions, as shown in Table 6. Upon power-up, the internal address counter points to the capability register.

Capability Register (User Read Only)

This register lists the capabilities of the TS, as detailed in the corresponding bit map.

Configuration Register (Read/Write)

This register controls the various operating modes of the TS, as detailed in the corresponding bit map.

Temperature Trip Point Registers (Read/Write)

The CAT6095 features 3 temperature limit registers, the **HLR**, **LLR** and **CLR** mentioned earlier. The temperature value recorded in the **TDR** is compared to the various limit values, and the result is used to activate the **EVENT** pin. To avoid undesirable **EVENT** pin activity, this pin is automatically disabled at power–up to allow the host to initialize the limit registers and the converter to complete the first conversion cycle under nominal supply conditions. Data format is two's complement with the LSB representing 0.25° C, as detailed in the corresponding bit maps.

Temperature Data Register (User Read Only)

This register stores the measured temperature, as well as trip status information. B15, B14 and B13 are the trip status bits, representing the relationship between measured temperature and the 3 limit values; these bits are not affected by EVENT status or by Configuration register settings. Measured temperature is represented by bits B12 to B0. Data format is two's complement, where B12 represents the sign, B11 represents 128°C, etc. and B0 represents 0.0625°C.

Manufacturer ID Register (Read Only)

The manufacturer ID assigned by the PCI–SIG trade organization to the CAT6095 device is 0x1B09.

Device ID and Revision Register (Read Only)

This register contains manufacturer specific device ID and device revision information.

Table 6. TEMPERATURE SENSOR REGISTERS

| Register Address | Register Name | Power-On Default | Read/Write |
|------------------|-----------------------------|------------------|------------|
| 0x00 | Capability Register | 0x007F | Read |
| 0x01 | Configuration Register | 0x0000 | Read/Write |
| 0x02 | High Limit Register | 0x0000 | Read/Write |
| 0x03 | Low Limit Register | 0x0000 | Read/Write |
| 0x04 | Critical Limit Register | 0x0000 | Read/Write |
| 0x05 | Temperature Data Register | Undefined | Read |
| 0x06 | Manufacturer ID Register | 0x1B09 | Read |
| 0x07 | Device ID/Revision Register | 0x0813 | Read |
| 0x08 – | Reserved | - | - |

Table 7. CAPABILITY REGISTER

| B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 |
|------|-------|-----|------|---------|-------|-----|-------|
| RFU | RFU | RFU | RFU | RFU | RFU | RFU | RFU |
| B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
| EVSD | TMOUT | RFU | TRES | G [1:0] | RANGE | ACC | EVENT |

| Bit | Description |
|--------------------|--|
| B15:B8 | Reserved for future use; can not be written; should be ignored; will typically read as 0 |
| B7 (Note 8) | 0: Configuration register bit 4 is frozen upon setting Configuration register bit 8 (i.e. a TS shut-down freezes the EVENT output) 1: Configuration register bit 4 is cleared upon setting Configuration register bit 8 (i.e. a TS shut-down de-asserts the EVENT output) |
| B6 | 0: The TS implements SMBus time-out within the range 10 to 60 ms 1: The TS implements SMBus time-out within the range 25 to 35 ms |
| B5 | 0: Pin A ₀ V _{HV} compliance required for RSWP/SPD compatibility not explicitly stated 1: Pin A ₀ V _{HV} compliance required for RSWP/SPD compatibility explicitly stated |
| B4:B3 | 00: LSB = $0.50^{\circ}C$ (9 bit resolution) 01: LSB = $0.25^{\circ}C$ (10 bit) 10: LSB = $0.125^{\circ}C$ (11 bit) 11: LSB = $0.0625^{\circ}C$ (12 bit) |
| B2 | 0: Positive Temperature Only 1: Positive and Negative Temperature |
| B1 | 0: ±2°C over the active range and ±3°C over the operating range (Class C) 1: ±1°C over the active range and ±2°C over the monitor range (Class B) |
| B0 | 0: Critical Temperature only 1: Alarm and Critical Temperature |

Configuration Register bit 4 can be cleared (but not set) after Configuration Register bit 8 is set, by writing a "1" to Configuration Register bit 5 (i.e. the EVENT output can be de-asserted during TS shut-down periods)

Table 8. CONFIGURATION REGISTER

| B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 |
|------------|------------|-------|-----------|------------|------------|-----------|------------|
| RFU | RFU | RFU | RFU | RFU | HYST | Г [1:0] | SHDN |
| B7 | B6 | B5 | B4 | B3 | B2 | B1 | В0 |
| TCRIT_LOCK | EVENT_LOCK | CLEAR | EVENT_STS | EVENT_CTRL | TCRIT_ONLY | EVENT_POL | EVENT_MODE |

| Bit | Description |
|-------------------------|--|
| B15:B11 | Reserved for future use; can not be written; should be ignored; will typically read as 0 |
| B10:B9 (Note 9) | 00: Disable hysteresis 01: Set hysteresis at 1.5°C 10: Set hysteresis at 3°C 11: Set hysteresis at 6°C |
| B8 (Note 13) | 0: Thermal Sensor is enabled; temperature readings are updated at sampling rate 1: Thermal Sensor is shut down; temperature reading is frozen to value recorded before SHDN |
| B7 (Note 12) | O: Critical trip register can be updated 1: Critical trip register cannot be modified; this bit can be cleared only at POR |
| B6 (Note 12) | Alarm trip registers can be updated Alarm trip registers cannot be modified; this bit can be cleared only at POR |
| B5 (Note 11) | 0: Always reads as 0 (self-clearing) 1: Writing a 1 to this position clears an event recording in interrupt mode only |
| B4 (Note 10) | 0: EVENT output pin is not being asserted 1: EVENT output pin is being asserted |
| B3 (Note 9) | 0: EVENT output disabled; <i>polarity dependent</i>: open-drain for bit B1 = 0 and grounded for B1 = 1 1: EVENT output enabled |
| B2 (Note 15) | event condition triggered by alarm or critical temperature limit crossing event condition triggered by critical temperature limit crossing only |
| B1 (Notes 9, 14) | 0: EVENT output active low 1: EVENT output active high |
| B0 (Note 9) | 0: Comparator mode 1: Interrupt mode |

9. Can not be altered (set or cleared) as long as either one of the two lock bits, B6 or B7 is set.

10. This bit is a *polarity independent* 'software' copy of the EVENT pin, i.e. it is under the control of B3.

11. Writing a '1' to this bit clears an event condition in Interrupt mode, but has no effect in comparator mode. When read, this bit always returns 0. Once the measured temperature exceeds the critical limit, setting this bit has no effect (see Figure 12).

12. Cleared at power-on reset (POR). Once set, this bit can only be cleared by a POR condition.

13. The TS powers up into active mode, i.e. this bit is cleared at power-on reset (POR). When the TS is shut down the ADC is disabled and the temperature reading is frozen to the most recently recorded value. The TS can not be shut down (B8 can not be set) as long as either one of the two lock bits, B6 or B7 is set. However, the bit can be cleared at any time.

14. The EVENT output is "open-drain" and requires an external pull-up resistor for either polarity. The "natural" polarity is "active low", as it allows "wired-or" operation on the EVENT bus.

15. Can not be set as long as lock bit B6 is set.

Table 9. HIGH LIMIT REGISTER

| B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 |
|-----|-----|-----|------|-------|--------|------|------|
| 0 | 0 | 0 | Sign | 128°C | 64°C | 32°C | 16°C |
| B7 | B6 | B5 | B4 | B3 | B2 | B1 | В0 |
| 8°C | 4°C | 2°C | 1°C | 0.5°C | 0.25°C | 0 | 0 |

Table 10. LOW LIMIT REGISTER

| B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 |
|-----|-----|-----|------|-------|--------|------|------|
| 0 | 0 | 0 | Sign | 128°C | 64°C | 32°C | 16°C |
| B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
| 8°C | 4°C | 2°C | 1°C | 0.5°C | 0.25°C | 0 | 0 |

Table 11. TCRIT LIMIT REGISTER

| B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 |
|-----|-----|-----|------|-------|--------|------|------|
| 0 | 0 | 0 | Sign | 128°C | 64°C | 32°C | 16°C |
| B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
| 8°C | 4°C | 2°C | 1°C | 0.5°C | 0.25°C | 0 | 0 |

Table 12. TEMPERATURE DATA REGISTER

| B15 | B14 | B13 | B12 | B11 | B10 | B9 | B8 |
|-------|------|-----|------|-------|---------------------|----------------------|-----------------------|
| TCRIT | HIGH | LOW | Sign | 128°C | 64°C | 32°C | 16°C |
| B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
| 8°C | 4°C | 2°C | 1°C | 0.5°C | 0.25°C (Note 16) | 0.125°C (Note 16) | 0.0625°C (Note 16) |

16. When applicable (as defined by Capability bit TRES), unsupported bits will read as 0

| Bit | Description | | | | |
|-----|--|--|--|--|--|
| B15 | 0: Temperature is below the TCRIT limit 1: Temperature is equal to or above the TCRIT limit | | | | |
| B14 | 0: Temperature is equal to or below the High limit 1: Temperature is above the High limit | | | | |
| B13 | 0: Temperature is equal to or above the Low limit 1: Temperature is below the Low limit | | | | |

Register Data Format

The values used in the temperature data register and the 3 temperature trip point registers are expressed in two's complement format. The measured temperature value is expressed with 12-bit resolution, while the 3 trip temperature limits are set with 10-bit resolution. The total temperature range is arbitrarily defined as 256°C, thus yielding an LSB of 0.0625°C for the measured temperature and 0.25°C for the 3 limit values. Bit B12 in all temperature registers represents the sign, with a '0' indicating a positive, and a '1' a negative value. In two's complement format, negative values are obtained by complementing their positive counterpart and adding a '1', so that the sum of opposite signed numbers, but of equal absolute value, adds up to zero.

Note that trailing '0' bits, are '0' irrespective of polarity. Therefore the don't care bits (B1 and B0) in the 10-bit resolution temperature limit registers, are always '0'.

| Binary (B12 to B0) | Hex | Temperature |
|--------------------|------|-------------|
| 1 1100 1001 0000 | 1C90 | –55°C |
| 1 1100 1110 0000 | 1CE0 | –50°C |
| 1 1110 0111 0000 | 1E70 | –25°C |
| 1 1111 1111 1111 | 1FFF | –0.0625°C |
| 0 0000 0000 0000 | 000 | 0°C |
| 0 0000 0000 0001 | 001 | +0.0625°C |
| 0 0001 1001 0000 | 190 | +25°C |
| 0 0011 0010 0000 | 320 | +50°C |
| 0 0111 1101 0000 | 7D0 | +125°C |

Table 13. 12-BIT TEMPERATURE DATA FORMAT

Event Pin Functionality

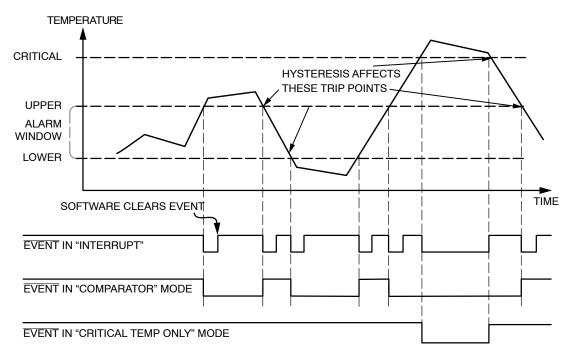
The **EVENT** output reacts to temperature changes as illustrated in Figure 15, and according to the operating mode defined by the Configuration register.

In **Interrupt Mode**, the enabled EVENT output will be asserted every time the temperature crosses one of the alarm window limits, and can be de-asserted by writing a '1' to the clear event bit (B5) in the configuration register. When the temperature exceeds the critical limit, the event remains asserted as long as the temperature stays above the critical limit and can not be cleared.

In **Comparator Mode**, the $\overline{\text{EVENT}}$ output is asserted outside the alarm window limits, while in **Critical Temperature Mode**, $\overline{\text{EVENT}}$ is asserted only above the critical limit. The exact trip limits are determined by the 3 temperature limit settings and the hysteresis offsets, as illustrated in Figure 16.

Following a TS shut-down request, the converter is stopped and the most recently recorded temperature value present in the TDR is frozen; the EVENT output will continue to reflect the state immediately preceding the shut-down command. Therefore, if the state of the EVENT output creates an undesirable bus condition, appropriate action must be taken either before or after shutting down the TS. This may require clearing the event, disabling the EVENT output or perhaps changing the EVENT output polarity.

In normal use, events are triggered by a change in recorded temperature, but the CAT6095 will also respond to limit register changes. Whereas recorded temperature values are updated at sampling rate frequency, limits can be modified at any time. The enabled EVENT output will react to limit changes as soon as the respective registers are updated. This feature may be useful during testing.



*EVENT cannot be cleared once the DUT temperature is greater than the critical temperature

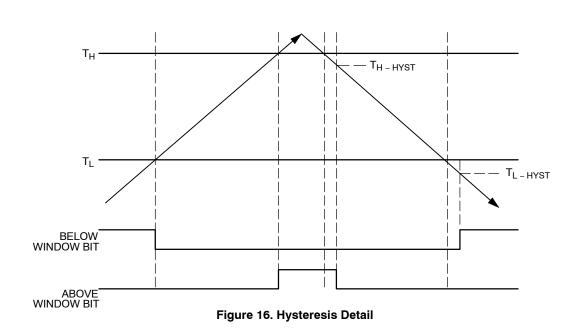
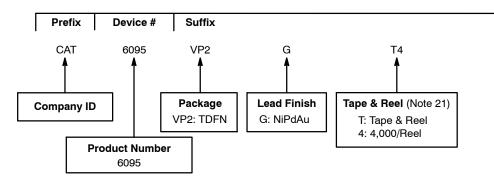


Figure 15. Event Detail

Example of Ordering Information



17. All packages are RoHS-compliant (Lead-free, Halogen-free)

18. The standard lead finish is NiPdAu.

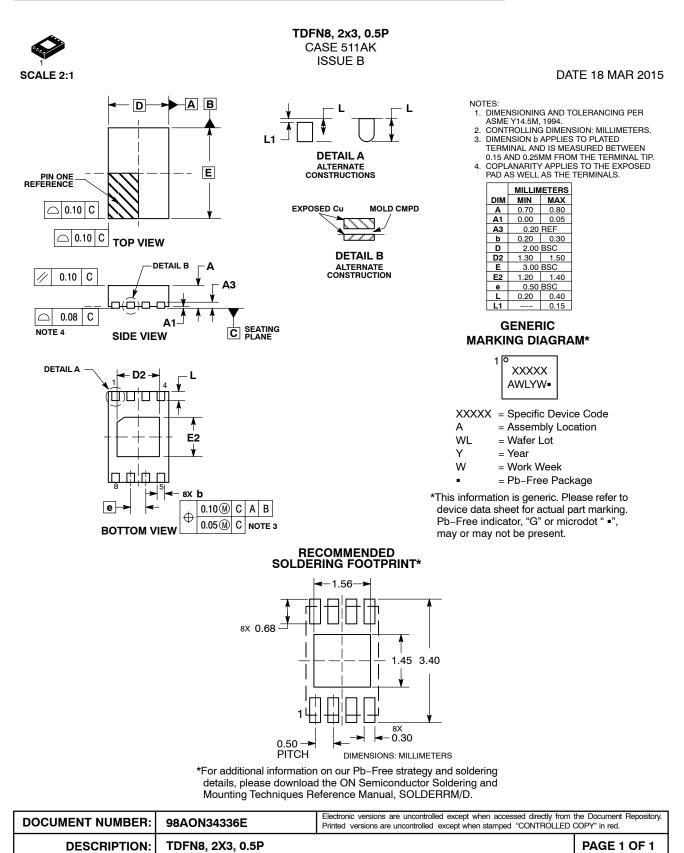
19. This device used in the above example is a CAT6095, in TDFN, NiPdAu Lead Frame, Tape & Reel, 4,000/Reel.

20. For additional package and temperature options, please contact your nearest ON Semiconductor Sales office.

21. For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ON Semiconductor is licensed by Philips Corporation to carry the I²C Bus Protocol.





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